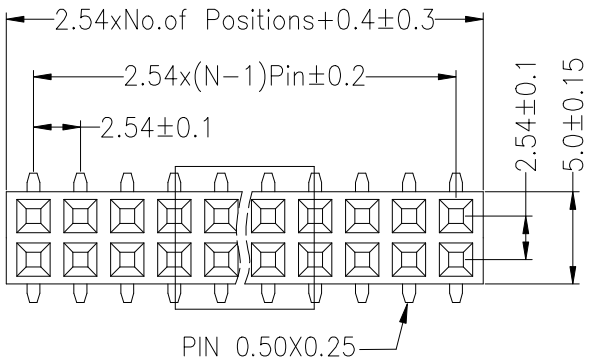
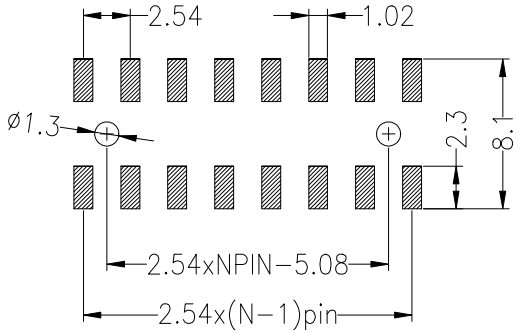
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



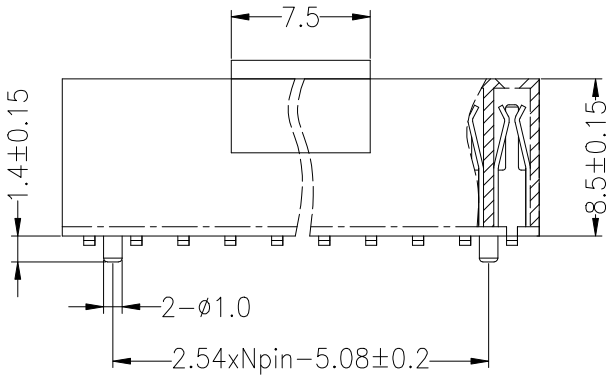
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

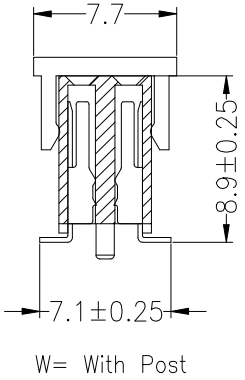


Ordering Information

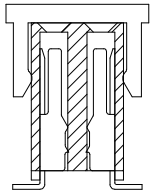
228502 XX X X XX M U X 0X

No.of Pins Per Row 2~40	Insulator Material Option	Post	Contact Plating			Packing
	C=BK−PA6T	W=With Post	G1:Gold Flash			0=PE Bag
	D=BK−PA46	N=W/O Post	G2:1.5U" Gold			A=Tray
	E=BK−PA9T		G3:2U" Gold			T=Tube
	F=BK−LCP		G4:3U" Gold			P=Tube+Cap
			G5:5U" Gold			R=Reel+Cap
			S0:Gold Flash/Tin			
			SN:Tin			





W= With Post



N= W/O Post

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.03.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	12.03.28	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	228502XXXXXXMUX0X
TITLE:	2.54PF H8.5mm 2xNpin SMT W5.0带夹持盖